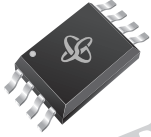


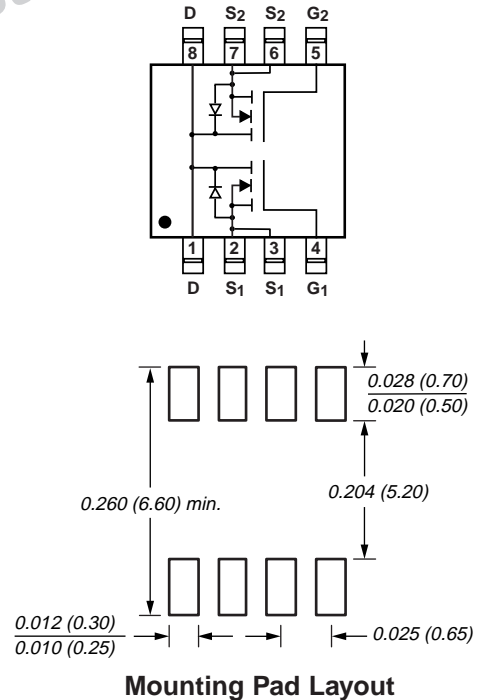
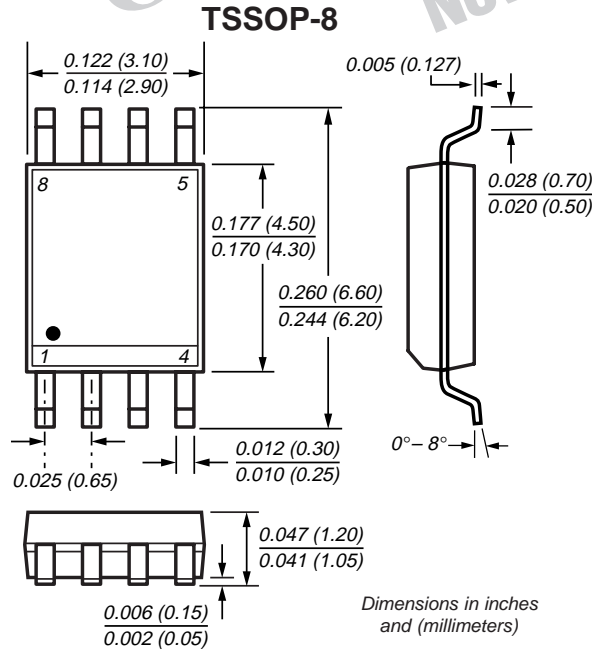
## Common-Drain Dual N-Channel MOSFET

Low  $V_{GS(th)}$   $V_{DS}$  20V  $R_{DS(ON)}$  22m $\Omega$   $I_D$  6.2A



TRENCH  
GENFET®

New Product



### Mechanical Data

**Case:** TSSOP-8 Package

**Terminals:** Leads solderable per MIL-STD-750, Method 2026

**High temperature soldering guaranteed:**  
250°C/10 seconds at terminals

**Mounting Position:** Any

**Weight:** 0.5g

### Features

- Advanced Trench Process Technology
- High Density Cell Design for Ultra Low On-Resistance
- Specially Designed for Li-ion battery packs use
- Designed for battery-switch applications

### Maximum Ratings and Thermal Characteristics ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	$V_{DS}$	20	V	
Gate-Source Voltage	$V_{GS}$	$\pm 12$		
Continuous Drain Current ( $T_J = 150^\circ\text{C}$ ) <sup>(1)</sup>	$I_D$	6.2	A	
Pulsed Drain Current	$I_{DM}$	30	A	
Maximum Power Dissipation <sup>(1)</sup>	$P_D$	$T_A = 25^\circ\text{C}$	1.5	W
		$T_A = 70^\circ\text{C}$	0.96	
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to 150	$^\circ\text{C}$	
Maximum Junction-to-Ambient <sup>(1)</sup> Thermal Resistance	$R_{\theta JA}$	83	$^\circ\text{C}/\text{W}$	

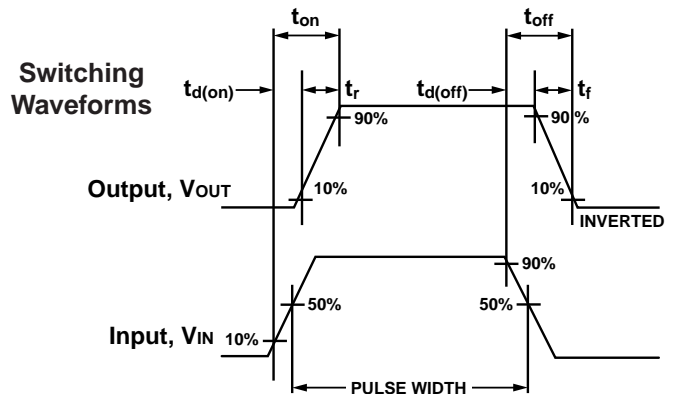
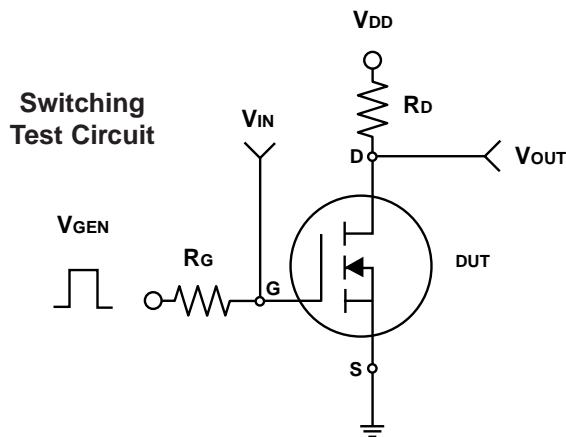
**Notes:** (1) Surface mounted on FR4 board,  $t \leq 10$  sec.

**Common-Drain Dual N-Channel MOSFET**

**Electrical Characteristics** (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	20	–	–	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.6	–	–	V
Gate Body Leakage	I <sub>GSS</sub>	V <sub>GS</sub> = ± 12V, V <sub>DS</sub> = 0V	–	–	±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V	–	–	1	μA
On-State Drain Current <sup>(1)</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> ≥ 5V, V <sub>GS</sub> = 4.5V	30	–	–	A
Drain-Source On-State Resistance <sup>(1)</sup>	R <sub>DSON</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6.2A	–	17.5	22	mΩ
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 5.3A	–	25	30	
Forward Transconductance <sup>(1)</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6.2A	–	26.5	–	S
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 4.5V I <sub>D</sub> = 6.2A	–	14	20	nC
Gate-Source Charge	Q <sub>gs</sub>		–	2.2	–	
Gate-Drain Charge	Q <sub>gd</sub>		–	3	–	
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> = 10V, R <sub>L</sub> = 10Ω I <sub>D</sub> = 1A, V <sub>GEN</sub> = 4.5V R <sub>G</sub> = 6Ω	–	11	30	ns
Turn-On Rise Time	t <sub>r</sub>		–	15	50	
Turn-Off Delay Time	t <sub>d(off)</sub>		–	43	100	
Fall Time	t <sub>f</sub>		–	22	50	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V f = 1.0 MHz	–	1240	–	pF
Output Capacitance	C <sub>oss</sub>		–	200	–	
Reverse Transfer Capacitance	C <sub>rss</sub>		–	120	–	
<b>Source-Drain Diode</b>						
Maximum Diode Forward Current	I <sub>S</sub>	–	–	–	1.7	A
Diode Forward Voltage	V <sub>S</sub> D	I <sub>S</sub> = 6.2A, V <sub>GS</sub> = 0V	–	0.8	1.2	V

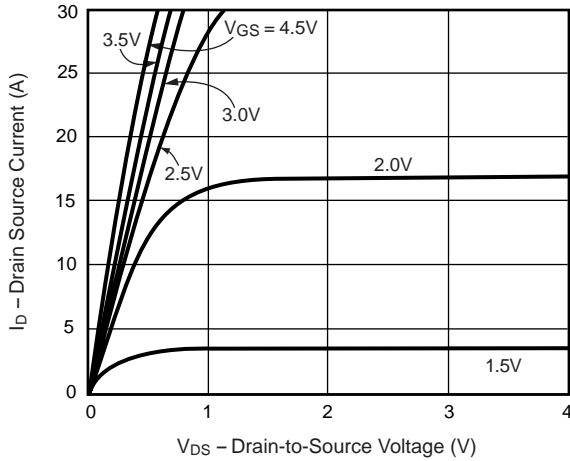
Note: (1) Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%



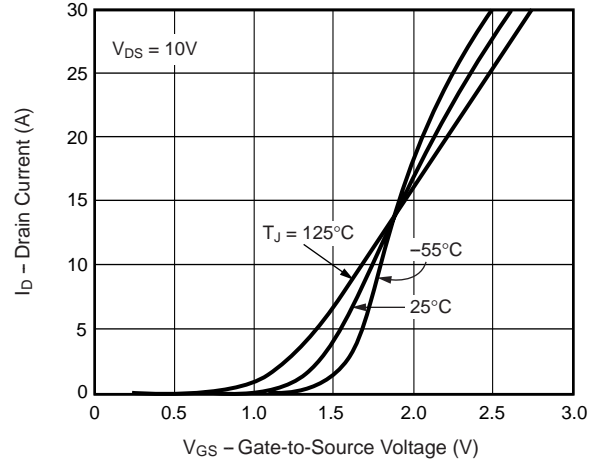
# Common-Drain Dual N-Channel MOSFET

## Ratings and Characteristic Curves ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

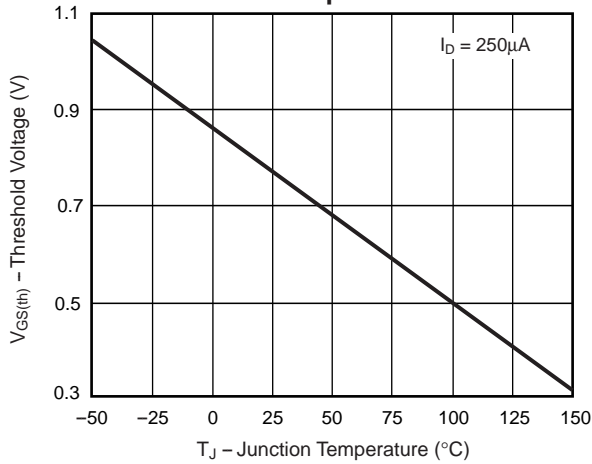
**Fig. 1 – Output Characteristics**



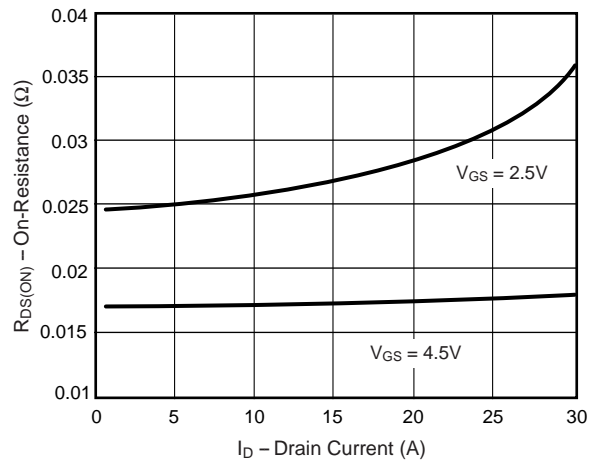
**Fig. 2 – Transfer Characteristics**



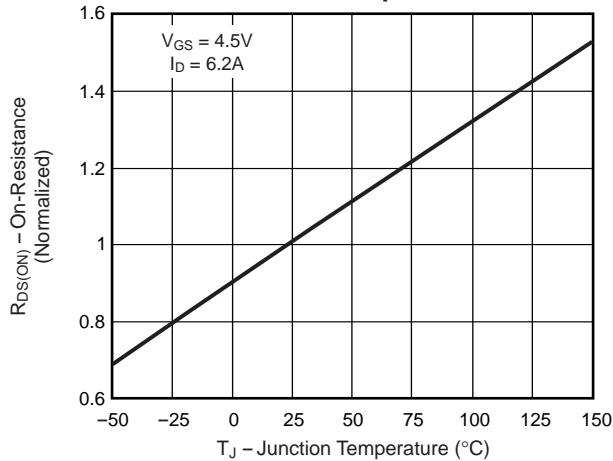
**Fig. 3 – Threshold Voltage vs. Temperature**



**Fig. 4 – On-Resistance vs. Drain Current**



**Fig. 5 – On-Resistance vs. Junction Temperature**



Common-Drain Dual N-Channel MOSFET

Ratings and Characteristic Curves (T<sub>A</sub> = 25°C unless otherwise noted)

Fig. 6 – On-Resistance vs. Gate-to-Source Voltage

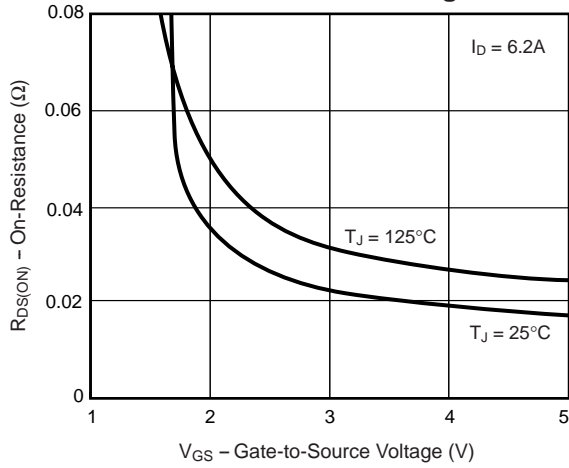


Fig. 7 – Gate Charge

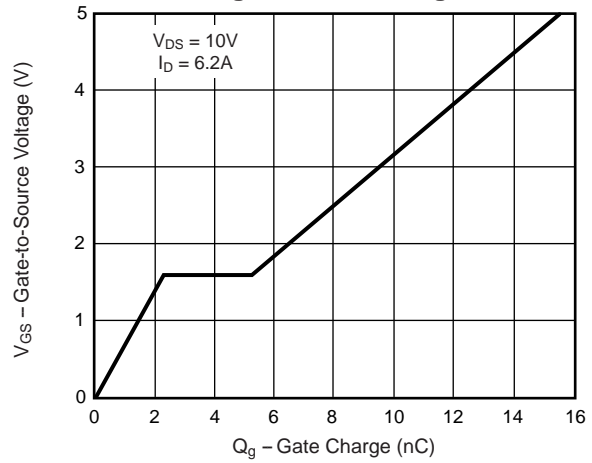


Fig. 8 – Capacitance

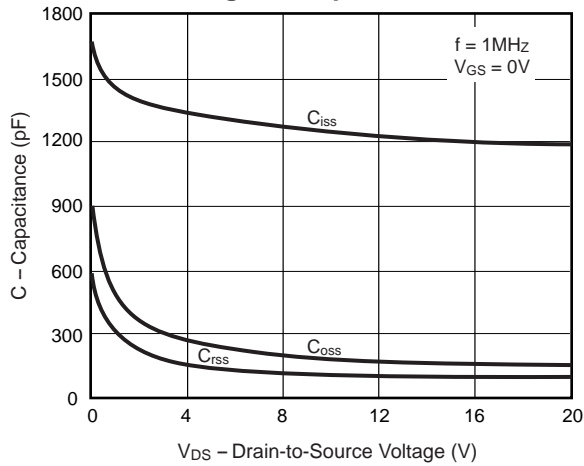
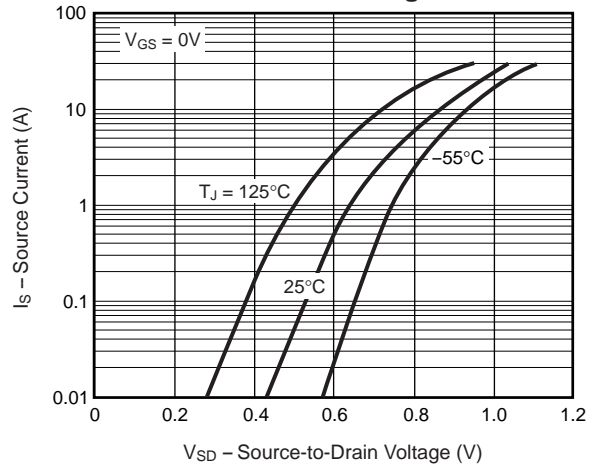


Fig. 9 – Source-Drain Diode Forward Voltage



Common-Drain Dual N-Channel MOSFET

Ratings and Characteristic Curves (T<sub>A</sub> = 25°C unless otherwise noted)

Fig. 10 – Breakdown Voltage vs. Junction Temperature

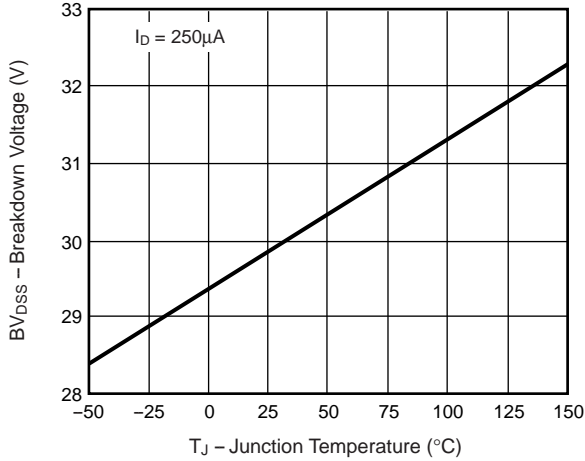


Fig. 11 – Transient Thermal Impedance

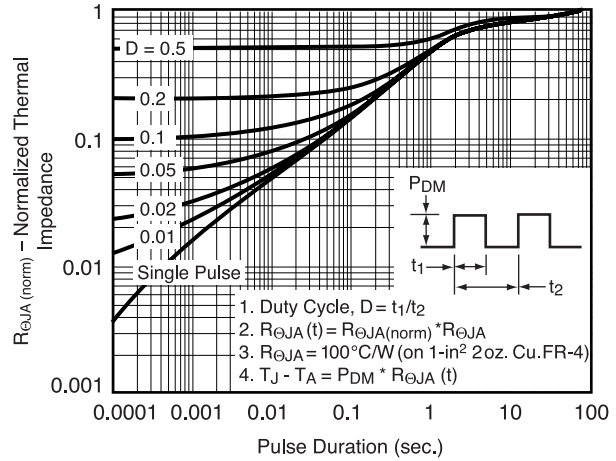


Fig. 12 – Power vs. Pulse Duration

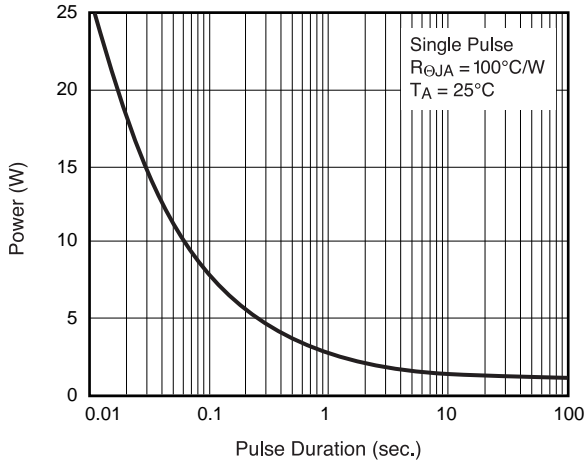


Fig. 13 – Maximum Safe Operating Area

